

# NEC's 1/4W SINGLE CONTROL L-BAND SPDT SWITCH

# **UPG2012TB**

#### **FEATURES**

SUPPLY VOLTAGE:

VDD = 2.7 to 3.0 V (2.8 V TYP.)

SWITCH CONTROL VOLTAGE:

Vcont (H) = 2.7 to 3.0 V (2.8 V TYP.) Vcont (L) = -0.2 to +0.2 V (0 V TYP.)

LOW INSERTION LOSS:

 $\label{eq:lins1} $\text{Lins1} = 0.27 \text{ dB TYP.} @ f = 0.5 \text{ to } 1.0 \text{ GHz, VDD} = 2.8 \text{ V, Vcont} = 2.8 \text{ V/0 V} \\ \text{Lins2} = 0.30 \text{ dB TYP.} @ f = 2.0 \text{ GHz, VDD} = 2.8 \text{ V, Vcont} = 2.8 \text{ V/0 V} \\ \text{Lins3} = 0.35 \text{ dB TYP.} @ f = 2.5 \text{ GHz, VDD} = 2.8 \text{ V, Vcont} = 2.8 \text{ V/0 V} \\ \text{(Reference value)}$ 

· HIGH ISOLATION:

ISL1 = 28 dB TYP. @ f = 0.5 to 2.0 GHz, VDD = 2.8 V, Vcont = 2.8 V/0 V ISL2 = 25 dB TYP. @ f = 2.5 GHz, VDD = 2.8 V, Vcont = 2.8 V/0 V (Reference value)

· HIGH-DENSITY SURFACE MOUNTING:

6-pin super minimold package ( $2.0 \times 1.25 \times 0.9$  mm)

### **DESCRIPTION**

NEC's UPG2012TB is a single control GaAs MMIC L-band SPDT (Single Pole Double Throw) switch for mobile phone and L-band applications.

This device can operate from 0.5 to 2.5 GHz, with low insertion loss and high isolation.

This device is housed in a 6-pin super minimold package, suitable for high-density surface mounting.

#### **APPLICATIONS**

- · L-band digital cellular or cordless handsets
- PCS, W-LAN, WLL and Bluetooth<sup>TM</sup>
- · Short Range Wireless

#### ORDERING INFORMATION

Part Number	Package	Marking	Supplying Form	
UPG2012TB-E3-A	6-pin super minimold	G3A	Embossed tape 8 mm wide	
			• Pin 1, 2, 3 face the perforation side of the tape	
			Qty 3 kpcs/reel	

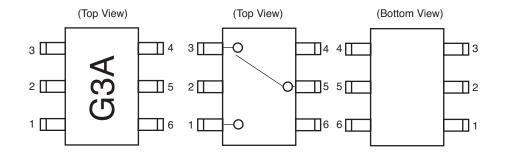
Remark To order evaluation samples, contact your nearby sales office.

Part number for sample order: UPG2012TB

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

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### PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



Pin No.	Pin Name		
1	OUTPUT1		
2	2 GND		
3	OUTPUT2		
4	VCont		
5	INPUT		
6	Vdd		

### **TRUTH TABLE**

Vcont	INPUT-OUTPUT1	INPUT-OUTPUT2		
Low	OFF	ON		
High	ON	OFF		

## ABSOLUTE MAXIMUM RATINGS (TA = 25°C, unless otherwise specified)

Parameter	Symbol	Ratings	Unit
Supply Voltage	V <sub>DD</sub>	+6.0	V
Switch Control Voltage	V <sub>cont</sub>	+6.0	V
Input Power	Pin	+26	dBm
Power Dissipation	P□	150 Note	mW
Operating Ambient Temperature	Та	-45 to +85	°C
Storage Temperature	T <sub>stg</sub>	–55 to +150	°C

**Note** Mounted on double-sided copper-clad  $50 \times 50 \times 1.6$  mm epoxy glass PWB, T<sub>A</sub> = +85°C

### **RECOMMENDED OPERATING RANGE** (TA = 25°C, unless otherwise specified)

Parameter	Symbol	MIN.	TYP.	MAX.	Unit
Switch Voltage	V <sub>DD</sub>	2.7	2.8	3.0	V
Switch Control Voltage (H)	Vcont (H)	2.7	2.8	3.0	V
Switch Control Voltage (L)	Vcont (L)	-0.2	0	0.2	V

### **ELECTRICAL CHARACTERISTICS**

(TA = +25°C, VDD = 2.8 V, Vcont = 2.8 V/O V, DC blocking capacitors = 56 pF, unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss1	Lins1	f = 0.5 to 1.0 GHz	-	0.27	0.50	dB
Insertion Loss2	L <sub>INS2</sub>	f = 2.0 GHz	_	0.30	0.50	dB
Isolation1	ISL1	f = 0.5 to 2.0 GHz	24	28	_	dB
Input Return Loss	RLin	f = 0.5 to 2.5 GHz	15	20	_	dB
Output Return Loss	RLout	f = 0.5 to 2.5 GHz	15	20	_	dB
0.1 dB Gain Compression Input Power Note	Pin(0.1 dB)	f = 2.0 GHz	+17.5	+20.5	_	dBm
Supply Current	IDD		_	50	100	μΑ
Switching Control Current	Icont		-	4	20	μΑ

**Note** Pin (0.1 dB) is the measured input power level when the insertion loss increases 0.1 dB more than that of linear range.

### STANDARD CHARACTERISTICS FOR REFERENCE

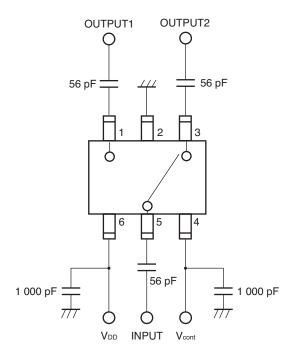
(TA = +25°C, VDD = 2.8 V, Vcont = 2.8 V/0 V, DC blocking capacitors = 56 pF, unless otherwise specified)

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Insertion Loss3	LINS3	f = 2.5 GHz	_	0.30	-	dB
Isolation2	ISL2	f = 2.5 GHz	_	25	_	dB
1 dB Gain Compression Input Power Note	Pin(1 dB)	f = 2.0 GHz	-	+24.0	-	dBm
Switching Control Speed	tsw		-	300	-	ns

Caution It is necessary to use DC blocking capacitors with the device.

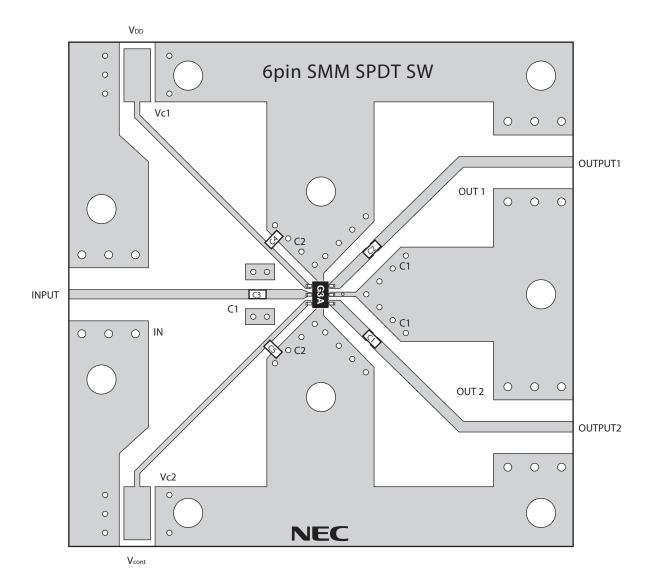
The value of DC blocking capacitors should be chosen to accommodate the frequency of operation, bandwidth, switching speed and the condition with actual board of your system. The range of recommended DC blocking capacitor value is less than 100 pF.

**EVALUATION CIRCUIT** (VDD = 2.8 V, Vcont = 2.8 V/0 V, DC blocking capacitors = 56 pF)



The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

# ILLUSTRATION OF THE TEST CIRCUIT ASSEMBLED ON EVALUATION BOARD

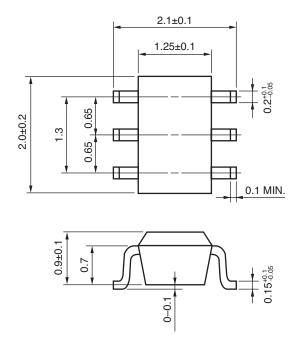


## USING THE NEC EVALUATION BOARD

Symbol	Values
C1, C2, C3	56 pF
C4, C5	1 000 pF

## PACKAGE DIMENSIONS

6-PIN SUPER MINIMOLD (UNIT: mm)



#### RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions		Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature)	: 260°C or below	IR260
	Time at peak temperature	: 10 seconds or less	
	Time at temperature of 220°C or higher	: 60 seconds or less	
	Preheating time at 120 to 180°C	: 120±30 seconds	
	Maximum number of reflow processes	: 3 times	
	Maximum chlorine content of rosin flux (% mass)	: 0.2%(Wt.) or below	
VPS	Peak temperature (package surface temperature)	: 215°C or below	VP215
	Time at temperature of 200°C or higher	: 25 to 40 seconds	
	Preheating time at 120 to 150°C	: 30 to 60 seconds	
	Maximum number of reflow processes	: 3 times	
	Maximum chlorine content of rosin flux (% mass)	: 0.2%(Wt.) or below	
Wave Soldering	Peak temperature (molten solder temperature)	: 260°C or below	WS260
	Time at peak temperature	: 10 seconds or less	
	Preheating temperature (package surface temperature)	: 120°C or below	
	Maximum number of flow processes	: 1 time	
	Maximum chlorine content of rosin flux (% mass)	: 0.2%(Wt.) or below	
Partial Heating	Peak temperature (pin temperature)	: 350°C or below	HS350
	Soldering time (per side of device)	: 3 seconds or less	
	Maximum chlorine content of rosin flux (% mass)	: 0.2%(Wt.) or below	

Caution Do not use different soldering methods together (except for partial heating).

Life Support Applications

These NEC products are not intended for use in life support devices, appliances, or systems where the malfunction of these prod to result in personal injury. The customers of CEL using or selling these products for use in such applications do so at their CEL for all damages resulting from such improper use or sale.

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